

AMENDMENTS TO THE CLAIMS

This listing of claims will replace all prior versions, and listings, of claims in the application.

Listing of Claims:

1-19 (Canceled)

20. (New) A composition comprising a polyamide matrix, comprising:

at least 2% by weight of electrically conductive fillers; and

at least 1% by weight of antistatic agents;

the percentages by weight being expressed with respect to the total weight of the composition.

21. (New) The composition as claimed in claim 20, exhibiting a surface resistivity of between  $10^5 \Omega$  and  $10^{11} \Omega$ , measured according to Standard IEC 61340-4-1.

22. (New) The composition as claimed in claim 20, having a discharge time of greater than or equal to 10 seconds, measured according to Standard IEC 61340-5-1.

23. (New) The composition as claimed in claim 20, havingg from 2 to 50% by weight of electrically conductive fillers, with respect to the total weight of the composition.

24. (New) The composition as claimed in claim 20, wherein the electrically conductive fillers are a carbon black, a metal, a graphite, a conductive polymer, a glass or an inorganic filler coated with a metal layer.

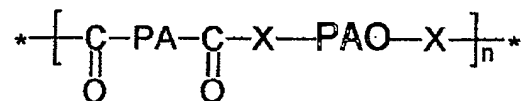
25. (New) The composition as claimed in claim 20, having from 2 to 10% by weight of carbon black as electrically conductive fillers, with respect to the total

weight of the composition.

26. (New) The composition as claimed in claim 20, having from 1 to 30% by weight of antistatic agents, with respect to the total weight of the composition.

27. (New) The composition as claimed in claim 20, wherein the antistatic agents are a polyetheramide, a sodium alkylsulfonate, an alkylbenzenesulfonate, primary, secondary or tertiary amines, an ethoxylated amine, an ethoxylated alcohol, glyceryl monostearates, distearates or tristearates.

28. (New) The composition as claimed in claim 20, wherein the antistatic agent is a polyetheramide represented by the formula (I):



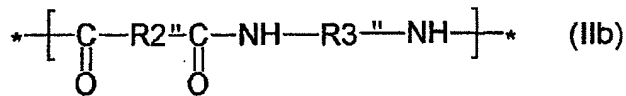
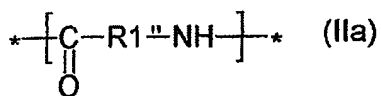
in which:

n is an integer between 5 and 50;

X represents an oxygen atom or an NH group;

PAO represents a poly(alkylene oxide) block;

PA represents a polyamide block, the repeat unit of which is represented by either of the formulae (IIa) or (IIb):



in which:  $R^1$ ,  $R^2$  and  $R^3$  are aromatic or aliphatic radicals having 4 to 36 carbon atoms.

29. (New) The composition as claimed in claim 28, wherein the radical  $R^1$  is a linear divalent pentyl radical.
30. (New) The composition as claimed in claim 28, wherein the PAO block is a poly(ethylene oxide) block.
31. (New) The composition as claimed in claim 20, wherein the polyamide matrix is composed of at least one (co)polyamide which is: (co)polyamide 6; 4; 11; 12; 4,6; 6,6; 6,9; 6,10; 6,12; 6,18; 6,36; 6(T); 9(T); 6(I); MXD6; their copolymers or their blends.
32. (New) The composition as claimed in claim 20, wherein the composition further comprises at least one modifier of the impact strength chosen from the group consisting of: ethylene-propylene (EP) optionally grafted with maleic anhydride, ethylene-propylene-diene (EPDM) terpolymer optionally grafted with maleic anhydride, styrene-maleic anhydride (SMA), ultra-low-density polyethylene (ULDPE), linear low density polyethylene (LLDPE), styrene-butadiene (SBS and SBR) compounds, styrene-ethylene-butadiene-styrene (SEBS) compounds, polypropylene (PP), acrylic elastomers, copolymers and terpolymers of ethylene with acrylic or methacrylic derivatives and/or with vinyl acetate, ionomers, acrylonitrile-butadiene-styrene (ABS) terpolymer and acrylic-styrene-acrylonitrile (ASA) terpolymer.
33. (New) A process for the preparation of a polyamide composition as claimed in claim 20, comprising the step of blending at least 2% by weight of electrically

conductive fillers and at least 1% by weight of antistatic agents with a polyamide matrix, optionally in the molten state.

34. (New) A process for the preparation of a polyamide composition as claimed in claim 20, comprising the step of blending the polyamide matrix with:

a concentrated blend based on a thermoplastic matrix comprising at least 20% by weight of electrically conductive fillers, and at least 1% by weight of antistatic agents.

35. (New) The process as claimed in claim 34, wherein the thermoplastic matrix is chosen from the group consisting of: the (co)polyamide, ethylene-vinyl acetate (EVA) copolymer, ethylene-acrylic acid (EAA), polyethylene (PE), polypropylene (PP), their copolymers and their blends.

36. (New) A process for the manufacture of an article by forming a composition as claimed in claim 20 by an extrusion process, a molding process or an injection process.

37. (New) An article obtained by forming a composition as claimed in claim 20.

38. (New) The article as claimed in claim 37, painted by a process of applying a paint by electrostatic deposition.